Direct Structural Observation of a Molecular Junction by High-Energy X-Ray Reflectometry

The Harvard community has made this article openly available. Please share how this access benefits you. Your story matters

<table>
<thead>
<tr>
<th>Citation</th>
<th>Lefenfeld, Michael, Julian Baumert, Eli Sloutskin, Ivan Kuzmenko, Peter Pershan, Moshe Deutsch, Colin Nuckolls, and Benjamin M. Ocko. 2006. Direct structural observation of a molecular junction by high-energy x-ray reflectometry. PNAS 103(8): 2541-2545.</th>
</tr>
</thead>
<tbody>
<tr>
<td>Published Version</td>
<td>doi:10.1073/pnas.0508070103</td>
</tr>
<tr>
<td>Citable link</td>
<td><a href="http://nrs.harvard.edu/urn-3:HUL.InstRepos:10354240">http://nrs.harvard.edu/urn-3:HUL.InstRepos:10354240</a></td>
</tr>
<tr>
<td>Terms of Use</td>
<td>This article was downloaded from Harvard University’s DASH repository, and is made available under the terms and conditions applicable to Other Posted Material, as set forth at <a href="http://nrs.harvard.edu/urn-3:HUL.InstRepos:dash.current.terms-of-use#LAA">http://nrs.harvard.edu/urn-3:HUL.InstRepos:dash.current.terms-of-use#LAA</a></td>
</tr>
</tbody>
</table>
Direct structural observation of a molecular junction by high-energy x-ray reflectometry

Michael Lefenfeld*, Julian Baumert†, Eli Sloutskin®, Ivan Kuzmenko®, Peter Pershan*, Moshe Deutsch®, Colin Nuckolls*, and Benjamin M. Ocko**

*Department of Chemistry, Columbia University, New York, NY 10027; †Department of Physics, Brookhaven National Laboratory, Upton, NY 11973; ‡Department of Physics, Bar-Ilan University, Ramat-Gan 52900, Israel; §Complex Materials Consortium Collaborative Access Team (CMC-CAT), Advanced Photon Source, Argonne National Laboratory, Argonne, IL 60439; and ¶Department of Physics, Harvard University, Cambridge, MA 02138

Edited by Stuart Lindsay, Arizona State University, Tempe, AZ, and accepted by the Editorial Board December 12, 2005 (received for review September 9, 2005)

We report a direct angstrom resolution measurement of the structure of a molecular-size electronic junction comprising a single (or a double) layer of alkyl-thiol and alkyl-silane molecules at the buried interface between solid silicon and liquid mercury. The high-energy synchrotron x-ray measurements reveal densely packed layers comprising roughly interface-normal molecules. The monolayer’s thickness is found to be 3–4 Å larger than that of similar layers at the free surfaces of both mercury and silicon. The origins of this and the other unusual features detected are discussed in this article. Measurements of the bilayer junction with an applied potential did not show visible changes in the surface normal structure.

In nanoscience and nanotechnology and, in particular, the emerging field of molecular electronics, individual molecules have to be inserted into a nanoscale environment such that they perform a prescribed electronic function. Clearly, the function and performance of the devices depend critically on the structure and packing of the molecules (1). Yet, studying the structure of such devices poses formidable experimental challenges. To make further progress, it is important to systematically study the structural properties of these surfaces and interfaces after charge transfer through SAMs in contact with another Hg electrode (8), a solid metal, or a doped semiconductor electrode (9–11). Although the structure of SAMs has been investigated on the free surface of solid metals (6, 7), insulators (12), liquid mercury (13, 14), and aqueous supports (15) by using a variety of techniques, they have not previously been investigated at buried interfaces.

Results and Discussion

Fig. 1 shows the x-ray reflectivity of the interface between the Hg surface and the clean Si wafer. The background, measured by rotating the sample slightly away from the specular condition, has been subtracted. The solid line is the Fresnel reflectivity, \( R_f(q_r) \), of an ideally smooth Si/Hg interface of zero width. It is calculated from the critical wave vector, \( q_c = 0.0605 \text{ Å}^{-1} \), obtained from the known bulk electron densities of Si and Hg. This \( q_c \) corresponds to a grazing incidence angle, relative to the surface of the sample, of 0.106° of the x-ray beam at 32 keV. The monotonic decrease of the reflected intensity by over eight orders of magnitude to 1.2 \( \times 10^{-3} \) at \( q_r = 0.6 \text{ Å}^{-1} \) shows that the buried interface is clean and that there is no uniform film of impurities in the junction. The deviation of the measured \( R(q_r) \) from \( R_f(q_r) \) can be accounted for by assuming a 4.4-Å Gaussian roughness for the interface (dashed curve). This roughness is close to that determined for the Si wafer at the air interface before the experiments but exceeds the intrinsic 1-Å capillary roughness of the mercury/vapor interface (14), demonstrating that the roughness of the interface is determined by the silicon substrate.

The measured x-ray reflectivities of the octadecanethiol (C\(_{18}\)SH), the octadecyltrichlorosilane (OTS), and the bilayer molecular junctions, normalized by the Fresnel reflectivity (\( R/R_f \)), are shown in Fig. 2. Whereas a single interface leads to a monotonically decreasing reflectivity (Fig. 1), the presence of an organic layer gives rise to interference between x-rays reflected from the organic layer/silicon and the organic layer/mercury interfaces, as shown in Fig. 4. As \( q_r \) is varied, this interference creates an oscillatory modulation of the reflected intensity, a pattern known as Kiessig fringes (13, 14, 16). The absence of fringes in Fig. 1 for the “empty” Si/Hg junction suggests that the...

Conflict of interest statement: No conflicts declared.

This paper was submitted directly (Track II) to the PNAS office. S.L. is a guest editor invited by the Editorial Board.

Abbreviations: SAM, self-assembled monolayer; OTS, octadecyltrichlorosilane; C\(_{18}\)SH, octadecanethiol; vdW, van der Waals; I–V, current–voltage.

M.L. and J.B. contributed equally to this work.

**To whom correspondence should be addressed. E-mail: ocko@bnl.gov.

© 2006 by The National Academy of Sciences of the USA
Hg is in direct contact with the silicon oxide, and no intermediate organic layer is present. By the same token, the clear Kiessig fringes observed in all reflectivities shown in Fig. 2 manifest the presence of an organic film between the silicon and the mercury. The Kiessig fringe spacing is given by \\

\[ q_z = \frac{2\pi}{L} \]

where \( L \) is the organic layer thickness. The amplitude of the fringes is related to the electron density in the various regions of the junction. Compared to organic monolayers at the liquid/air interface, the reflectivity modulations are out-of-phase by \( \pi/L \). This difference arises because at the air interface the electron density increases monotonically, whereas for the present junctions, the electron density change has a different sign at the two interfaces.

In Fig. 2a and b, the reflectivity curves of the monolayer junctions of C18SH and OTS are shown. Kiessig fringes with periods of \( \Delta q_z \approx 0.21 \text{ Å}^{-1} \) and \( \Delta q_z \approx 0.23 \text{ Å}^{-1} \), corresponding to layer thicknesses of \( \approx 29.9 \text{ Å} \) and \( \approx 27.3 \text{ Å} \), respectively, are clearly evident. In the case of the bilayer junction, Fig. 2c, the period of the Kiessig fringes decreases significantly to \( \Delta q_z \approx 0.13 \text{ Å}^{-1} \), yielding a total film thickness of \( \approx 52.4 \text{ Å} \). At the Hg/air interface, the C18SH SAM is known to display a thickness of 25.2 Å (14), whereas at the Si/air interface, the OTS SAM has a thickness of 24.2 Å (17). Both of these values are smaller than the respective thicknesses determined for the corresponding buried monolayers. The thickness of the buried bilayer is also found to be larger than the sum of the monolayer thicknesses at the air interface (49.4 Å). However, it is considerably smaller than the sum of the thicknesses of the two monolayer junctions (57.2 Å).

The reflectivities were analyzed additionally by using the Parratt formalism (18) to obtain the electron density profile of the junction from the measured reflectivity. Although the electron density profile of the C18SH buried interface could be modeled by a simple “box model” with a uniform density for each box, this was not possible for the other two molecular junctions. A model-free approach was used for these two junctions. Here an initial density profile is first chosen. It is then divided into a large number of thin (2.0-Å) layers, the densities of which are varied iteratively until a minimum \( \chi^2 \) value is reached. For our SAMs, a uniform-density layer was chosen as the starting profile. Its thickness was determined from the period of the Kiessig fringes observed in the measured reflectivity curve. The resulting fits (solid lines) and the corresponding electron densities (Insets) are displayed in Fig. 2.

For the Si-thiol-Hg interface, a good fit was obtained by using the box model with two independent layers: the first layer models the mercury surface layer, and the second layer models the C18SH monolayer bonded to the Hg. The mercury surface layer is found to display a more gradual density decay at the monolayer/mercury interface than that of a clean mercury/air interface (19, 20). This decay might result from the lower density of the bonded sulfur compared to the mercury. The fit yields a monolayer thickness of 29.6 ± 0.4 Å, consistent with the Kiessig fringe analysis, an electron density of 0.40 e/Å³, and a roughness of 3.0 Å at the silicon interface.
buried thiol layer is found to be \( \approx 30\% \) larger than that measured for a densely packed thiol SAM on the free mercury surface (14). The effective contrast between the electron density of the organic SAM and the mercury is therefore lower. A model comprising coexisting lying-down and standing-up molecules may account for the observations. However, coverage-dependent measurements and modeling are required to support this interpretation.

For the Si-OTS-Hg interface, the resulting electron density (Fig. 2b Inset) can be divided into three general regions: (i) \( z < 0 \) Å, the electron density corresponds to the mercury; (ii) above the mercury, a layer with an average density of 0.24 e/Å\(^2\), representing the OTS layer; and last (iii) an extended transition region of the electron density to that of silicon. The extended transition region cannot be explained solely by an increased silicon roughness. It is thought to originate from a combination of the interfacial roughness and the thin silicon oxide region. The silicon oxide, however, is not resolvable with the measured \( q_z \)-range: data at larger \( q_z \), measurable only with smoother substrates, may resolve the structure underlying this feature. The thickness of the OTS layer is determined from the distance between the midpoints of the electron density between the values of bulk mercury and OTS (\( z = 0.0 \) Å) and OTS and silicon (\( z = 28.4 \) Å), respectively. It is thus found to be 28.4 ± 0.5 Å, which is slightly larger than the value deduced from the period of the Kiessig fringes. In both the C\(_{18}\)SH and the OTS monolayer junctions, the interface thicknesses determined from both the Kiessig fringes and the Parratt fit are found to be larger than the corresponding values for SAMs at the air interface. However, at the air interface, the layer thickness corresponds to the distance between the terminal carbon and the mercury or silicon surface. In contrast, for a buried layer, the thickness is equal to the distance between the mercury and the silicon oxide surfaces. To obtain this distance from the molecular length, as reflected in the free surface measurements, one must add to this length also the C—H bond length of the terminal methyl group and the van der Waals (vdW) radii of both the terminal hydrogen atom and the silicon oxide or mercury surface. Consequently, we will reduce the thickness of the buried layer by these factors to calculate the effective thickness of the corresponding SAM at the air interface. The C—H bond length and the vdW radius of the terminal hydrogen atom are 1.1 Å and 1.2 Å, respectively. For the C\(_{18}\)SH buried interface the vdW radius of the silicon oxide is \( \approx 2.0 \) Å. Thus, the effective thickness of the SAM of the same molecule at the air interface will be 25.3 Å, which is 4.3 Å smaller than the measured thickness of 29.6 Å. The 25.3 Å effective thickness is in good agreement with the measured 25.2 Å thickness of the standing-up phase of C\(_{18}\)SH monolayers at the mercury/air interface. This clearly shows that the molecules are not significantly (\( \approx 5^\circ \)) tilted (14). In the case of the OTS junction, the vdW radius of the mercury is \( \approx 1.6 \) Å, resulting in an effective thickness of an OTS layer at the air interface of 24.5 Å, which is 3.9 Å smaller than the thickness of 28.4 Å measured here. This effective thickness is also in good agreement with the measured 24.2 Å thickness of OTS monolayers at the silicon/air interface (17). The results are summarized in Table 1.

The electron density profile of the bilayer junction shows a combination of the features observed for the monolayer junctions (see Fig. 2c Inset). The electron density decreases continuously from the mercury bulk density to the electron density corresponding to the organic layers. It is assumed that the two alkyl chains meet in the middle of the depletion point observed at \( z = 24.5 \) Å in the electron density profile shown in Fig. 2c Inset. Overall, this layer displays an average electron density of 0.30 e/Å\(^2\), corresponding well to that of closely packed alkyl tails of Langmuir films on water and mercury subphases (13, 15). An extended electron density transition region that reaches from the Si substrate into the region of the OTS layer also is observed by using the midpoint method described for the OTS monolayer, the thickness of the buried layer is found to be 48.1 ± 0.5 Å, corresponding to thicknesses of 24.5 Å and 23.6 Å for the C\(_{18}\)SH and the OTS layers, respectively. Thus, the thickness of the buried layer leads to values for the C\(_{18}\)SH and the OTS layers, which are reasonably close to the results at the air interface. Although it is clear that for these bilayers the vdW radii of the silicon or mercury surface do not have to be added to the molecular length, it is interesting to note that the hydrogen atoms of the terminal methyl group do not seem to lead to an increased thickness of the bilayer. This shorter length may suggest a slight interdigitation of the terminal hydrogen atoms of the two different hydrocarbon chains, a slight tilting of the two independent layers, or a larger number of gauche conformations at the chains’ ends as compared to that of a monolayer at the air interface.

For the Si-OTS-C\(_{18}\)SH-Hg buried junction, the effect of an applied potential on the reflectivity was monitored both by measuring the reflectivity at several fixed potentials and by measuring the potential dependence at fixed \( q_z \) positions. A uniform electrostatic-induced compression of the film would shift the modulations in the reflectivity curves to higher \( q_z \). A change in the junction spacing by several percent should thus be readily observed. In Fig. 3, the reflected intensity is shown at two \( q_z \) positions, 0.20 and 0.32 Å\(^{-1}\), as the applied potential was varied from -1 to 1 V. The chosen \( q_z \) positions correspond to points on the slope after the second and third maximum of the reflectivity curve of the bilayer junction prepared for the voltage scans. These current–voltage (I–V) measurements were carried

### Table 1. Layer thicknesses of the buried interfaces and the corresponding monolayers at the air interface

<table>
<thead>
<tr>
<th>Junction</th>
<th>Fig.</th>
<th>Kiessig</th>
<th>Fit</th>
<th>Air</th>
<th>Corrected</th>
</tr>
</thead>
<tbody>
<tr>
<td>C(_{18})SH 2a</td>
<td>29.9</td>
<td>29.6 ± 0.4</td>
<td>25.2*</td>
<td>25.3</td>
<td></td>
</tr>
<tr>
<td>OTS 2b</td>
<td>27.3</td>
<td>28.4 ± 0.5</td>
<td>24.2'</td>
<td>24.5</td>
<td></td>
</tr>
<tr>
<td>Bilayer 2c</td>
<td>52.4</td>
<td>48.1 ± 0.5</td>
<td>25.2*</td>
<td>25.3</td>
<td></td>
</tr>
</tbody>
</table>

Thicknesses obtained from the period of the Kiessig fringes and the fit of the data are given in comparison with the thickness of the monolayers at the air interface. The corrected thickness of the buried interfaces takes into account the terminal methyl group and the vdW radii of the terminal hydrogen atoms and the silicon or mercury surface.

*Published value from ref. 14.

'Published value from ref. 17.

Fig. 3. Potential-dependent x-ray reflectivity from the Si-OTS-C\(_{18}\)SH-Hg buried junctions at two fixed \( q_z \) positions, 0.20 and 0.32 Å\(^{-1}\). The magnitude of the current varied from 0.1 nA to 0.1 µA.
out to ensure electrical contact and the absence of shorts. Although our results for this single junction are in general agreement with the expected exponential-like $I$–$V$ characteristics (10, 11), some variability is observed among the several individual junctions measured. Thus, further measurements are required before a reliable $I$–$V$ curve can be presented for this junction.

The constant intensity in Fig. 3 clearly indicates that there is no detectable structural change despite a three-order-of-magnitude change in the current density. The reflectivity scans at several voltages also showed no detectable changes. Together, these results show that the compression of the junction is $<$2% for applied electric potentials in the range of $\pm$1 V. We note that the potential drop across the organic junction is somewhat reduced by the potential drop across the low-resistance native oxide. The contraction expected in the junction spacing can be estimated from the pressure induced by the voltage applied across the molecular junction. The pressure across the junction is given by $P = eE_0\varepsilon_0/2d^2$, where $\varepsilon = 2.2$ is the dielectric constant of alkane thiols (1) and $E_0 = 8.854 \times 10^{-12}$ F/m is the permittivity of free space. For a gap of $d = 5 \times 10^{-3}$ m and $V = 1.0$ V, the calculated pressure is $\approx$4 bars (1 bar $= 100$ kPa). By using the bulk compressibility of dodecan (99 ppm/bar) (21), the expected change in the gap spacing is $\approx$0.04%. This very small change in the gap spacing is consistent with the voltage independence of the reflectivity. Thus, these results suggest that the $I$–$V$ curves for this junction should not be dominated by structural changes associated with electrostatically induced compression.

In conclusion, this article demonstrates that x-ray reflectivity can be used to study in detail deeply buried self-assembled molecular layers. The method employs high-energy x-ray beams and allows determination of the molecular structure and phase with angstrom resolution, providing the first evidence of densely packed SAMs in buried interfaces. This method also has the capability of examining a range of molecules on two very important substrates at different surface coverages. The x-ray reflectivity measurements of the molecular junctions formed by either silane or thiol chemistry further illustrate the versatility of this technique. The combination of silane and thiol monolayers to a bilayer within the junction demonstrates the sensitivity of the experimental method toward structural changes within the buried interface. Measurements of the bilayer junction with an applied potential did not show visible changes in the surface normal structure. Because the compression scales as the square of the voltage-to-thickness ratio, junctions with shorter molecules and higher voltages should show noticeable structural changes. For example, a junction with a 1-nm gap at 2 V gives an estimated 4% change in the junction thickness, which should be observable as a change in the period of the Kiessig fringes in the x-ray reflectivity. Overall, combining x-ray reflectivity measurements with $I$–$V$ measurements should help to provide a better understanding of the structure–function relationship in a variety of molecular junctions.

Materials and Methods

Fig. 4 illustrates the experimental x-ray reflectivity geometry (16). This technique measures the Fourier transform of the laterally averaged electron density distribution in the surface normal direction. For a direct observation of the molecular structure of the buried interface, penetrating, high-energy x-ray beams are necessary (22). We have used beamline X-22A at the National Synchrotron Light Source of the Brookhaven National Laboratory, with an energy of 32 keV and a beam cross section of 0.1 $\times$ 0.5 mm$^2$. Additional measurements were carried out at ID9 with an energy of 24 keV at the Advanced Photon Source of the Argonne National Laboratory. At 32 keV, the beam passes through the 5-mm length of the silicon electrode ($5 \times 5 \times 1$ mm$^3$), which is comparable to the 4-mm x-ray attenuation length and is reflected from the Si-organic molecule-Hg junction exiting from the other side of the silicon electrode. The reflectivity $R(q_z)$ is the fraction of the incident intensity reflected by the interface, measured as a function of the wave vector transfer $q_z$, and corrected for the illuminated area.

Silicon wafers, (100) orientation, covered with their native oxide, supplied by Umicore Semiconductor Processing (Boston) and cut to the appropriate dimensions, were used as substrates. The wafers are cleaned in a sulfuric acid:hydrogen peroxide ($\text{H}_2\text{SO}_4:\text{H}_2\text{O}_2$: 70:30) mixture and rinsed in ultra-pure water before the experiments. Two methods were used to prepare the buried junctions. The first approach used C$_{18}$SH covalently bonded to the Hg surface at high coverage. In this Langmuir film approach, the C$_{18}$SH is dissolved in chloroform to create a micromolar solution, which is deposited on the free Hg surface (14). After the chloroform evaporates, an alkyl-thiol monolayer is formed. The area per molecule is calculated from the Hg surface area of $\approx$150 mm$^2$, calculated from the diameter of the circular Kel-F trough containing the mercury and the number of deposited molecules. The molecular surface coverage was chosen to be $\approx$19 A$^2$ per molecule, corresponding to a closely packed monolayer of fully extended, surface-normal aligned hydrocarbon chains (14). Next, the silicon wafer is lowered by a micrometer onto the mercury, which is contained in a Kel-F trough within a clean, sealed, aluminum sample cell. Once contact is made with the Hg surface, the wafer is raised until a slight capillary rise of the Hg surface is observed through visual inspection. This procedure ensures that the mercury does not block the entrance or exit of the x-ray beam through the sides of the Si wafer. The second approach to making molecular junctions uses a SAM of OTS, also an 18 carbon methyl-terminated molecule. Here, the OTS molecules are chemically bound to the native silicon oxide during extended immersion in either bicyclohexyl (ref. 23 and references therein) or toluene (24) solutions containing OTS. The contact between the OTS-covered silicon and the clean Hg surface was made by using the same procedure. A bilayer can also be formed by bringing the OTS-covered silicon into contact with the C$_{18}$SH-coated mercury. When applying an electric potential to the molecular junction, the native oxide on the back of the Si wafer is scratched, and conductive silver paint is applied to ensure good electric contact to the wafer. Because we did not visually observe a dewetting of the interface by the mercury or a rise of the mercury onto the sides of the wafer after the potential was applied, we excluded the possibility that the area of the junction changed. The x-ray reflectivity measurements were then performed at room temperature.

Fig. 4. A schematic of the deeply buried monolayer of C$_{18}$ chains, residing between the upper silicon electrode and lower mercury electrode. The entry and exit of the probing x-ray beam through the top silicon electrode is also shown.
M.L. and C.N. acknowledge financial support from the Nanoscale Science and Engineering Initiative of the National Science Foundation under National Science Foundation Award Number CHE-0117752 and from the New York State Office of Science, Technology, and Academic Research. Work at Brookhaven National Laboratory is supported by the U.S. Department of Energy, Division of Materials Science, under Contract DE-AC02–98CH10886. Support to M.D. by the German–Israeli Foundation, Jerusalem (GIF), is gratefully acknowledged. P.P. acknowledges support from the National Science Foundation under Grant NIRT 03-03916.